## AMENDMENTS TO THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the application:

## LISTING OF CLAIMS:

1-6. (cancelled).

7.(Currently amended) Method of controlling the gas flow within a device (1) for wet treating a substrate (W), the device comprising a liquid collector and at least two exhaust levels for separately collecting gas from the interior of the liquid collector, characterized in selectively individually generating different gas flow conditions in at least two of said exhaust levels.

8. (original) Method according to claim 7 wherein the different gas flow conditions are selected in a way to achieve substantially the same gas pressure adjacent to the rotating substrate above and below said substrate.